

SLVS561 - DECEMBER 2004



### description/ordering information

The TLV1117 is a positive low-dropout voltage regulator, designed to provide up to 800 mA of output current. The device is available in 1.5 V, 1.8 V, 2.5 V, 2.85 V, 3.3 V, 5 V, and adjustable output voltage options. All internal circuitry is designed to operate down to 1 V input-to-output differential. Dropout voltage is specified at a maximum of 1.3 V at 800 mA, decreasing at lower load currents.

The low-profile surface-mount KTP package allows the device to be used in applications where space is limited. The TLV1117 requires a minimum of 10  $\mu$ F of output capacitance for stability. Output capacitors of this size or larger normally are included in most regulator designs.

Unlike pnp-type regulators, where up to 10% of the output current is wasted as quiescent current, the quiescent current of the TLV1117 flows into the load, increasing efficiency.

The TLV1117C device is characterized for operation over the virtual junction temperature range of  $0^{\circ}$ C to  $125^{\circ}$ C, and the TLV1117I device is characterized for operation over the virtual junction temperature range of  $-40^{\circ}$ C to  $125^{\circ}$ C.



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SLVS561 – DECEMBER 2004

### description/ordering information (continued)

Тј	V <sub>O</sub> TYP (V)	PACKAGET		ORDERABLE PART NUMBER	TOP-SIDE MARKING	
		PowerFLEX (KTE)	Reel of 2000	TLV1117-15CKTER		
		PowerFLEX/TO-252* (KTP)	Reel of 2000	TLV1117-15CKTPR		
		QFN (DRJ)	Reel of 1000	TLV1117-15CDRJR		
			Tube of 80	TLV1117-15CDCY		
	1.5 V	SOT-223 (DCY)	Reel of 2500	TLV1117-15CDCYR		
		TO-220 (KCS)	Tube of 50	TLV1117-15CKCS		
			Tube of	TLV1117-15CKTT		
		TO-263 (KTT)	Reel of	TLV1117-15CKTTR		
		PowerFLEX (KTE)	Reel of 2000	TLV1117-18CKTER		
		PowerFLEX/TO-252* (KTP)	Reel of 2000	TLV1117-18CKTPR		
		QFN (DRJ)	Reel of 1000	TLV1117-18CDRJR		
			Tube of 80	TLV1117-18CDCY		
	1.8 V	SOT-223 (DCY)	Reel of 2500	TLV1117-18CDCYR		
		TO-220 (KCS)	Tube of 50	TLV1117-18CKCS		
			Tube of	TLV1117-18CKTT		
		TO-263 (KTT)	Reel of	TLV1117-18CKTTR		
		PowerFLEX (KTE)	Reel of 2000	TLV1117-25CKTER		
		PowerFLEX/TO-252* (KTP)	Reel of 2000	TLV1117-25CKTPR		
		QFN (DRJ)	Reel of 1000	TLV1117-25CDRJR		
		SOT-223 (DCY)	Tube of 80	TLV1117-25CDCY		
0°C to 125°C	2.5 V		Reel of 2500	TLV1117-25CDCYR		
		TO-220 (KCS)	Tube of 50	TLV1117-25CKCS		
			Tube of	TLV1117-25CKTT		
		TO-263 (KTT)	Reel of	TLV1117-25CKTTR		
		PowerFLEX (KTE)	Reel of 2000	TLV1117-285CKTER		
		PowerFLEX/TO-252* (KTP)	Reel of 2000	TLV1117-285CKTPR		
		QFN (DRJ)	Reel of 1000	TLV1117-285CDRJR		
			Tube of 80	TLV1117-285CDCY		
	2.85 V	SOT-223 (DCY)	Reel of 2500	TLV1117-285CDCYR		
		TO-220 (KCS)	Tube of 50	TLV1117-285CKCS		
			Tube of	TLV1117-285CKTT		
		TO-263 (KTT)	Reel of	TLV1117-285CKTTR		
		PowerFLEX (KTE)	Reel of 2000	TLV1117-33CKTER		
		PowerFLEX/TO-252* (KTP)	Reel of 2000	TLV1117-33CKTPR		
		QFN (DRJ)	Reel of 1000	TLV1117-33CDRJR		
			Tube of 80	TLV1117-33CDCY		
	3.3 V	SUT-223 (DCY)	Reel of 2500	TLV1117-33CDCYR		
		TO-220 (KCS)	Tube of 50	TLV1117-33CKCS		
			Tube of	TLV1117-33CKTT		
		TO-263 (KTT)	Reel of	TLV1117-33CKTTR		

### **TLV1117C ORDERING INFORMATION**

\*Complies with TO-252, variation AC.

<sup>†</sup>Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



SLVS561 - DECEMBER 2004

Тј	V <sub>O</sub> TYP (V)	PACKAGE <sup>†</sup>		ORDERABLE PART NUMBER	TOP-SIDE MARKING			
		PowerFLEX (KTE)	Reel of 2000	TLV1117-50CKTER	PREVIEW			
		PowerFLEX/TO-252* (KTP)	Reel of 2000	TLV1117-50CKTPR	PREVIEW			
		QFN (DRJ)	Reel of 1000	TLV1117-50CDRJR	PREVIEW			
		00T 000 (DO)/)	Tube of 80	TLV1117-50CDCY	PREVIEW			
	5 V	SOT-223 (DCY)	Reel of 2500	TLV1117-50CDCYR				
		TO-220 (KCS)	Tube of 50	TLV1117-50CKCS	PREVIEW			
		TO-263 (KTT)	Tube of	TLV1117-50CKTT	DDEVIEW			
			Reel of	TLV1117-50CKTTR	PREVIEW			
0°C to 125°C		PowerFLEX (KTE)	Reel of 2000	TLV1117CKTER	TLV1117C			
		PowerFLEX/TO-252* (KTP)	Reel of 2000	TLV1117CKTPR	TV1117			
		QFN (DRJ)	Reel of 1000	TLV1117CDRJR	PREVIEW			
		007 000 (DO) ()	Tube of 80	TLV1117CDCY				
	ADJ	SO1-223 (DCY)	Reel of 2500	TLV1117CDCYR	V4			
		TO-220 (KCS)	Tube of 50	TLV1117CKCS	TLV1117C			
			Tube of	TLV1117CKTT	DDEVIEW			
		10-263 (KTT)	Reel of	TLV1117CKTTR				

## TLV1117C ORDERING INFORMATION (continued)

\*Complies with TO-252, variation AC.

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



SLVS561 – DECEMBER 2004

### **TLV1117I ORDERING INFORMATION**

Тј	V <sub>O</sub> TYP (V)	PACKAGE <sup>†</sup>		ORDERABLE PART NUMBER	TOP-SIDE MARKING
		PowerFLEX (KTE)	Reel of 2000	TLV1117-15IKTER	
		PowerFLEX/TO-252* (KTP)	Reel of 2000	TLV1117-15IKTPR	
		QFN (DRJ)	Reel of 1000	TLV1117-15IDRJR	
			Tube of 80	TLV1117-15IDCY	
	1.5 V	SOT-223 (DCY)	Reel of 2500	TLV1117-15IDCYR	
		TO-220 (KCS)	Tube of 50	TLV1117-15IKCS	
			Tube of	TLV1117-15IKTT	
		TO-263 (KTT)	Reel of	TLV1117-15IKTTR	
		PowerFLEX (KTE)	Reel of 2000	TLV1117-18IKTER	
		PowerFLEX/TO-252* (KTP)	Reel of 2000	TLV1117-18IKTPR	
		QFN (DRJ)	Reel of 1000	TLV1117-18IDRJR	
			Tube of 80	TLV1117-18IDCY	
–40°C to 125°C	1.8 V	SOT-223 (DCY)	Reel of 2500	TLV1117-18IDCYR	
		TO-220 (KCS)	Tube of 50	TLV1117-18IKCS	
			Tube of	TLV1117-18IKTT	
		TO-263 (KTT)	Reel of	TLV1117-18IKTTR	
	2.5 V	PowerFLEX (KTE)	Reel of 2000	TLV1117-25IKTER	
		PowerFLEX/TO-252* (KTP)	Reel of 2000	TLV1117-25IKTPR	
		QFN (DRJ)	Reel of 1000	TLV1117-25IDRJR	
		SOT-223 (DCY)	Tube of 80	TLV1117-25IDCY	
			Reel of 2500	TLV1117-25IDCYR	
		TO-220 (KCS)	Tube of 50	TLV1117-25IKCS	
			Tube of	TLV1117-25IKTT	
		TO-263 (KTT)	Reel of	TLV1117-25IKTTR	
		PowerFLEX (KTE)	Reel of 2000	TLV1117-285IKTER	
		PowerFLEX/TO-252* (KTP)	Reel of 2000	TLV1117-285IKTPR	
		QFN (DRJ)	Reel of 1000	TLV1117-285IDRJR	
			Tube of 80	TLV1117-285IDCY	
-40°C to 125°C	2.85 V	SO1-223 (DCY)	Reel of 2500	TLV1117-285IDCYR	
		TO-220 (KCS)	Tube of 50	TLV1117-285IKCS	
			Tube of	TLV1117-285IKTT	- F
		10-263 (K11)	Reel of	TLV1117-285IKTTR	
		PowerFLEX (KTE)	Reel of 2000	TLV1117-33IKTER	
		PowerFLEX/TO-252* (KTP)	Reel of 2000	TLV1117-33IKTPR	
		QFN (DRJ)	Reel of 1000	TLV1117-33IDRJR	
		SOT-223 (DCY)	Tube of 80	TLV1117-33IDCY	
–40°C to 125°C	3.3 V	SOT-223 (DCY)	Reel of 2500	TLV1117-33IDCYR	
		TO-220 (KCS)	Tube of 50	TLV1117-33IKCS	
			Tube of	TLV1117-33IKTT	
		10-263 (KTT)	Reel of	TLV1117-33IKTTR	

\*Complies with TO-252, variation AC. † Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



SLVS561 - DECEMBER 2004

### description/ordering information (continued)

Тј	V <sub>O</sub> TYP (V)	PACKAGE <sup>†</sup>		ORDERABLE PART NUMBER	TOP-SIDE MARKING
		PowerFLEX (KTE)	Reel of 2000	TLV1117-50IKTER	PREVIEW
		PowerFLEX/TO-252* (KTP)	Reel of 2000	TLV1117-50IKTPR	PREVIEW
		QFN (DRJ)	Reel of 1000	TLV1117-50DRJR	PREVIEW
	<b>5</b> \(		Tube of 80	TLV1117-50IDCY	PREVIEW
	5 V	SOT-223 (DCY)	Reel of 2500	TLV1117-50IDCYR	
		TO-220 (KCS)	Tube of 50	TLV1117-50IKCS	PREVIEW
		TO-263 (KTT)	Tube of	TLV1117-50IKTT	DDEVIEW
4000 to 40500			Reel of	TLV1117-50IKTTR	FREVIEW
-40°C to 125°C		PowerFLEX (KTE)	Reel of 2000	TLV1117IKTER	TLV1117I
		PowerFLEX/TO-252* (KTP)	Reel of 2000	TLV1117IKTPR	TY1117
		QFN (DRJ)	Reel of 1000	TLV1117IDRJR	PREVIEW
		007 000 (DO) ()	Tube of 80	TLV1117IDCY	1/0
	ADJ	SOT-223 (DCY)	Reel of 2500	TLV1117IDCYR	V2
		TO-220 (KCS)	Tube of 50	TLV1117IKCS	TLV1117I
			Tube of	TLV1117IKTT	PREVIEW
		IU-263 (KTT) Reel		TLV1117IKTTR	

### **TLV1117I ORDERING INFORMATION (continued)**

\*Complies with TO-252, variation AC.

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

DEVICE COMPONENT COUNT				
Transistors				
Diodes				
Resistors				
Capacitors				
JFET				
Tunnels (emitter R)				



SLVS561 - DECEMBER 2004

### functional block diagram



### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Continuous input voltage	15 V
Operating virtual junction temperature 1	150°C
Storage temperature range, T <sub>stg</sub>	150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.



SLVS561 - DECEMBER 2004

### package thermal data (see Note 1)

PACKAGE	BOARD	θ <b>J</b> Ρ*	θJC	θJA
PowerFLEX (KTE)	High K, JESD 51-5	2.7°C/W		23°C/W
PowerFLEX/TO-252 (KTP)	High K, JESD 51-5	3°C/W		28°C/W
QFN (DRJ)	High K, JESD 51-5	TBD		TBD
SOT (DCY)	High K, JESD 51-7		4°C/W	53°C/W
TO-263 (KTT)	High K, JESD 51-5	TBD		TBD
TO-220 (KCS)	High K. JESD 51-5	3°C/W		19°C/W

\*For packages with exposed thermal pads, such as QFN, PowerPAD, and PowerFLEX,  $\theta_{JP}$  is defined as the thermal resistance between the die junction and the bottom of the exposed pad.

NOTE 1: Maximum power dissipation is a function of  $T_J(max)$ ,  $\theta_{JA}$ , and  $T_A$ . The maximum allowable power dissipation at any allowable ambient temperature is  $P_D = (T_J(max) - T_A)/\theta_{JA}$ . Operating at the absolute maximum  $T_J$  of 150°C can affect reliability.

### recommended operating conditions

			мін‡	MAX	UNIT
	Input voltage	TLV1117	2.7	15	
		TLV1117-15	2.9	15	
		TLV1117-18	3.2	15	
VIN		TLV1117-25	3.9	15	V
		TLV1117-285	4.25	15	
		TLV1117-33	4.7	15	
		TLV1117-50	6.4	15	
IOUT	Output current	-		0.8	А
<b>T</b> .		TLV1117C	0	125	•••
IJ	Operating virtual junction temperature range	TLV1117I	-40	125	Ĵ

<sup>†</sup> The input-to-output differential across the regulator should provide for some margin against regulator operation at the maximum dropout (for a particular current value). This margin is needed to account for tolerances in both the input voltage (lower limit) and the output voltage (upper limit). The absolute minimum V<sub>IN</sub> for a desired maximum output current can be calculated by the following:

VIN(min) = VOUT(max) + VDO(max @ rated current)



SLVS561 - DECEMBER 2004

## TLV1117C electrical characteristics, $T_J = 0^{\circ}C$ to 125°C, all typical values are at $T_J = 25^{\circ}C$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS <sup>†</sup>		MIN	TYP	MAX	UNIT	
	V <sub>IN</sub> – V <sub>OUT</sub> = 2 V, I <sub>OUT</sub> = 10 mA, T <sub>J</sub> = 25°C		1.238	1.250	1.262		
	IOUT = 10 mA to 800 mA, VIN - VOUT = 1.4 V to 10 V	TLV1117	1.225	1.250	1.270		
	V <sub>IN</sub> = 3.5 V, I <sub>OUT</sub> = 10 mA, T <sub>J</sub> = 25°C		1.485	1.500	1.515		
	V <sub>IN</sub> = 2.9 V to 10 V, I <sub>OUT</sub> = 0 to 800 mA	TLV1117-15	1.470	1.500	1.530	1	
	V <sub>IN</sub> = 3.8 V, I <sub>OUT</sub> = 10 mA, T <sub>J</sub> = 25°C		1.782	1.800	1.818		
	V <sub>IN</sub> = 3.2 V to 10 V, I <sub>OUT</sub> = 0 to 800 mA	TLV1117-18	1.764	1.800	1.836		
	V <sub>IN</sub> = 4.5 V, I <sub>OUT</sub> = 10 mA, T <sub>J</sub> = 25°C		2.475	2.500	2.525		
Output voltage, VOUT	V <sub>IN</sub> = 3.9 V to 10 V, I <sub>OUT</sub> = 0 to 800 mA	TLV1117-25	2.450	2.500	2.550	V	
	V <sub>IN</sub> = 4.85 V, I <sub>OUT</sub> = 10 mA, T <sub>J</sub> = 25°C		2.820	2.850	2.880		
	V <sub>IN</sub> = 4.25 V to 10 V, I <sub>OUT</sub> = 0 to 800 mA	TLV1117-285	2.790	2.850	2.910		
	V <sub>IN</sub> = 4.1 V, I <sub>OUT</sub> = 0 to 500 mA		2.790	2.850	2.910		
	V <sub>IN</sub> = 5 V, I <sub>OUT</sub> = 10 mA, T <sub>J</sub> = 25°C		3.267	3.300	3.333		
	V <sub>IN</sub> = 4.75 V to 10 V, I <sub>OUT</sub> = 0 to 800 mA	TLV1117-33	3.235	3.300	3.365		
	V <sub>IN</sub> = 7 V, I <sub>OUT</sub> = 10 mA, T <sub>J</sub> = 25°C		4.950	5.000	5.050		
Line regulation	V <sub>IN</sub> = 6.5 V to 12 V, I <sub>OUT</sub> = 0 to 800 mA	TLV1117-50	4.900	5.000	5.100		
	I <sub>OUT</sub> = 10 mA, V <sub>IN</sub> – V <sub>OUT</sub> = 1.5 V to 13.75 V	TLV1117		0.035	0.2	%	
	I <sub>OUT</sub> = 0 mA, V <sub>IN</sub> = 2.9 V to 10 V	TLV1117-15		1	6		
	I <sub>OUT</sub> = 0 mA, V <sub>IN</sub> = 3.2 V to 10 V	TLV1117-18		1	6		
Line regulation	I <sub>OUT</sub> = 0 mA, V <sub>IN</sub> = 3.9 V to 10 V	TLV1117-25		1	6	mV	
	I <sub>OUT</sub> = 0 mA, V <sub>IN</sub> = 4.25 V to 10 V	TLV1117-285		1	6		
	I <sub>OUT</sub> = 0 mA, V <sub>IN</sub> = 4.75 V to 15 V	TLV1117-33		1	6		
	I <sub>OUT</sub> = 0 mA, V <sub>IN</sub> = 6.5 V to 15 V	TLV1117-50		1	10		
	I <sub>OUT</sub> = 10 mA to 800 mA, V <sub>IN</sub> - V <sub>OUT</sub> = 3 V	TLV1117		0.2	0.4	%	
	I <sub>OUT</sub> = 0 to 800 mA, V <sub>IN</sub> = 2.9 V	TLV1117-15		1	10		
	I <sub>OUT</sub> = 0 to 800 mA, V <sub>IN</sub> = 3.2 V	TLV1117-18		1	10		
Load regulation	I <sub>OUT</sub> = 0 to 800 mA, V <sub>IN</sub> = 3.9 V	TLV1117-25		1	10	.,	
	I <sub>OUT</sub> = 0 to 800 mA, V <sub>IN</sub> = 4.25 V	TLV1117-285		1	10	mv	
	I <sub>OUT</sub> = 0 to 800 mA, V <sub>IN</sub> = 4.75 V	TLV1117-33		1	10		
	I <sub>OUT</sub> = 0 to 800 mA, V <sub>IN</sub> = 6.5 V	TLV1117-50		1	15		
	I <sub>OUT</sub> = 100 mA			1.1	1.20		
Dropout voltage, V <sub>DO</sub> (see Note 2)	I <sub>OUT</sub> = 500 mA			1.15	1.25	V	
(000 11010 2)	I <sub>OUT</sub> = 800 mA			1.2	1.3		
Current limit	$V_{IN} - V_{OUT} = 5 V, T_J = 25^{\circ}C$		0.8	1.2	1.5	А	
Minimum load current	V <sub>IN</sub> = 15 V	TLV1117		1.7	5	mA	
Quiescent current	$V_{IN} \le 15 V$	All fixed voltage options		5	10	mA	
Thermal regulation	30 ms pulse,	$T_A = 25^{\circ}C$		0.01	0.1	%/W	
Ripple rejection	V <sub>IN</sub> – V <sub>OUT</sub> = 3 V, V <sub>ripple</sub> = 1 V <sub>pp</sub>	f = 120 Hz	60	78		dB	

<sup>†</sup> All characteristics are measured with a 10-μF capacitor across the input and a 10-μF capacitor across the output. Pulse testing techniques are used to maintain the junction temperature as close to the ambient temperature as possible.

NOTE 2: Dropout is defined as the V<sub>IN</sub> to V<sub>OUT</sub> differential at which V<sub>OUT</sub> drops 100 mV below the value of V<sub>OUT</sub>, measured at  $V_{IN} = V_{OUT}(nom) + 1.5 V$ .



SLVS561 – DECEMBER 2004

# TLV1117C electrical characteristics, $T_J = 0^{\circ}C$ to 125°C, all typical values are at $T_J = 25^{\circ}C$ (unless otherwise noted) (continued)

PARAMETER	TEST CONDITIONS <sup>†</sup>	MIN	TYP	MAX	UNIT
ADJUSTMENT pin current			80	120	μΑ
Change in ADJUSTMENT pin current	Change in ADJUSTMENT pin current IOUT = 10 mA to 800 mA, VIN - VOUT = 1.4 V to 10 V			5	μA
Temperature stability	T <sub>J</sub> = full range		0.5		%
Long-term stability	1000 hrs, no load $T_A = 125^{\circ}C$		0.3		%
Output noise voltage (% of VOUT)	f = 10 Hz to 100 kHz,		0.003		%

<sup>†</sup> All characteristics are measured with a 10-μF capacitor across the input and a 10-μF capacitor across the output. Pulse testing techniques are used to maintain the junction temperature as close to the ambient temperature as possible.



SLVS561 - DECEMBER 2004

## TLV1117I electrical characteristics, $T_J = -40^{\circ}C$ to $125^{\circ}C$ , all typical values are at $T_J = 25^{\circ}C$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS <sup>†</sup>		MIN	TYP	MAX	UNIT	
	V <sub>IN</sub> – V <sub>OUT</sub> = 2 V, I <sub>OUT</sub> = 10 mA, T <sub>J</sub> = 25°C		1.238	1.250	1.262		
	I <sub>OUT</sub> = 10 mA to 800 mA, V <sub>IN</sub> – V <sub>OUT</sub> = 1.4 V to 10 V	TLV1117	1.200	1.250	1.290		
	V <sub>IN</sub> = 3.5 V, I <sub>OUT</sub> = 10 mA, T <sub>J</sub> = 25°C		1.485	1.500	1.515		
	V <sub>IN</sub> = 2.9 V to 10 V, I <sub>OUT</sub> = 0 to 800 mA	ILV1117-15	1.440	1.500	1.560		
Output voltage, V <sub>OUT</sub>	V <sub>IN</sub> = 3.8 V, I <sub>OUT</sub> = 10 mA, T <sub>J</sub> = 25°C		1.782	1.800	1.818		
	V <sub>IN</sub> = 3.2 V to 10 V, I <sub>OUT</sub> = 0 to 800 mA	TLV1117-18	1.728	1.800	1.872		
	V <sub>IN</sub> = 4.5 V, I <sub>OUT</sub> = 10 mA, T <sub>J</sub> = 25°C		2.475	2.500	2.525		
Output voltage, VOUT	V <sub>IN</sub> = 3.9 V to 10 V, I <sub>OUT</sub> = 0 to 800 mA	TLV1117-25	2.400	2.500	2.600	V	
	V <sub>IN</sub> = 4.85 V, I <sub>OUT</sub> = 10 mA, T <sub>J</sub> = 25°C		2.820	2.850	2.880		
	V <sub>IN</sub> = 4.25 V to 10 V, I <sub>OUT</sub> = 0 to 800 mA	TLV1117-285	2.736	2.850	2.964		
	V <sub>IN</sub> = 5 V, I <sub>OUT</sub> = 10 mA, T <sub>J</sub> = 25°C		3.267	3.300	3.333		
	V <sub>IN</sub> = 4.75 V to 10 V, I <sub>OUT</sub> = 0 to 800 mA	TLV1117-33	3.168	3.300	3.432		
	V <sub>IN</sub> = 7 V, I <sub>OUT</sub> = 10 mA, T <sub>J</sub> = 25°C	T1)////7 50	4.950	5.000	5.050		
	$V_{IN} = 6.5 \text{ V to } 12 \text{ V}, I_{OUT} = 0 \text{ to } 800 \text{ mA}$	TLV1117-50	4.800	5.000	5.200		
	$I_{OUT}$ = 10 mA, $V_{IN} - V_{OUT}$ = 1.5 V to 13.75 V	TLV1117		0.035	0.3	%	
	I <sub>OUT</sub> = 0 mA, V <sub>IN</sub> = 2.9 V to 10 V	TLV1117-15		1	4.5	m)/	
	I <sub>OUT</sub> = 0 mA, V <sub>IN</sub> = 3.2 V to 10 V	TLV1117-18		1	5.5		
Line regulation	$I_{OUT}$ = 0 mA, $V_{IN}$ = 3.9 V to 10 V	TLV1117-25		1	7.5		
	I <sub>OUT</sub> = 0 mA, V <sub>IN</sub> = 4.25 V to 10 V	TLV1117-285		1	8.5	mv	
Line regulation	$I_{OUT}$ = 0 mA, $V_{IN}$ = 4.75 V to 15 V	TLV1117-33		1	10		
	$I_{OUT} = 0$ mA, $V_{IN} = 6.5$ V to 15 V	TLV1117-50		1	15		
	$I_{OUT}$ = 10 mA to 800 mA, $V_{IN} - V_{OUT}$ = 3 V	TLV1117		0.2	0.5	%	
	$I_{OUT}$ = 0 to 800 mA, $V_{IN}$ = 2.9 V	TLV1117-15		1	7.5		
	$I_{OUT}$ = 0 to 800 mA, $V_{IN}$ = 3.2 V	TLV1117-18		1	9		
Load regulation	$I_{OUT}$ = 0 to 800 mA, $V_{IN}$ = 3.9 V	TLV1117-25		1	12.5	~~\/	
	$I_{OUT}$ = 0 to 800 mA, $V_{IN}$ = 4.25 V	TLV1117-285		1	14.5	mv	
	$I_{OUT}$ = 0 to 800 mA, $V_{IN}$ = 4.75 V	TLV1117-33		1	15		
	$I_{OUT}$ = 0 to 800 mA, $V_{IN}$ = 6.5 V	TLV1117-50		1	20		
	I <sub>OUT</sub> = 100 mA			1.10	1.30		
Dropout voltage, VDO (see Note 2)	I <sub>OUT</sub> = 500 mA			1.15	1.35	V	
· · ·	I <sub>OUT</sub> = 800 mA			1.20	1.40		
Current limit	$V_{IN} - V_{OUT} = 5 V, T_J = 25^{\circ}C$		0.8	1.2	1.5	А	
Minimum load current	V <sub>IN</sub> = 15 V	TLV1117		1.7	5	mA	
Quiescent current	$V_{IN} \le 15 V$	All fixed- voltage options		5	15	mA	
Thermal regulation	30-ms pulse,	$T_A = 25^{\circ}C$		0.01	0.1	%/W	
Ripple rejection	$V_{IN} - V_{OUT} = 3 V, V_{ripple} = 1 V_{pp}$	f = 120 Hz	60	75		dB	

<sup>†</sup> All characteristics are measured with a 10-μF capacitor across the input and a 10-μF capacitor across the output. Pulse testing techniques are used to maintain the junction temperature as close to the ambient temperature as possible.

NOTE 2: Dropout is defined as the V<sub>IN</sub> to V<sub>OUT</sub> differential at which V<sub>OUT</sub> drops 100 mV below the value of V<sub>OUT</sub>, measured at  $V_{IN} = V_{OUT}(nom) + 1.5 V$ .



SLVS561 – DECEMBER 2004

## TLV1117I electrical characteristics, $T_J = 40^{\circ}C$ to $125^{\circ}C$ , all typical values are at $T_J = 25^{\circ}C$ (unless otherwise noted) (continued)

PARAMETER	TEST CONDITIONS <sup>†</sup>		MIN	TYP	MAX	UNIT
ADJUSTMENT pin current				80	120	μA
Change in ADJUSTMENT pin current IOUT = 10 mA to 800 mA, VIN - VOUT = 1.4 V to 10 V				0.2	10	μA
Temperature stability	T <sub>J</sub> = full range			0.5		%
Long-term stability	1000 hrs, no load	$T_A = 125^{\circ}C$		0.3		%
Output noise voltage (% of VOUT)	f = 10 Hz to 100 kHz,			0.003		%

<sup>†</sup> All characteristics are measured with a 10-μF capacitor across the input and a 10-μF capacitor across the output. Pulse testing techniques are used to maintain the junction temperature as close to the ambient temperature as possible.

### **GRAPHS (PREVIEW):**

- Figure 1. Short-Circuit Current vs (VIN-VOUT)
- Figure 2. Load Regulation vs Temperature
- Figure 3. Ripple Rejection vs Frequency (ADJ Version)
- Figure 4. Ripple Rejection vs Current (ADJ Version)
- Figure 5. Temperature Stability
- Figure 6. ADJ Pin Current vs Temperature
- Figure 7. TLV1117-25 Load Transient Response
- Figure 8. TLV1117–25 Line Transient Response
- Figure 9. TLV1117–285 Load Transient Response
- Figure 10. TLV1117-285 Line Transient Response

Figure 11. TLV1117-33 Load Transient Response

Figure 12. TLV1117-33 Line Transient Response



SLVS561 - DECEMBER 2004



VOUT is calculated as:

 $V_{OUT} = V_{REF} \left( 1 + \frac{R2}{R1} \right) + (I_{ADJ} \times R2)$ 

Since  $I_{\mbox{ADJ}}$  typically is 55  $\mu \mbox{A},$  it is negligible in most applications.

- NOTES: A. Output capacitor selection is critical for regulator stability. The recommended minimum is  $10-\mu$ F tantalum or  $50-\mu$ F aluminum electrolytic, with either one having an ESR between  $0.3 \Omega$  and  $22 \Omega$ . Larger C<sub>OUT</sub> values benefit the regulator by improving transient response and loop stability.
  - B.  $C_{ADJ}$  can be used to improve ripple rejection. Ensure that the impedance of  $C_{ADJ}$  prevent the ripple from being amplified. If  $C_{ADJ}$  is used, then a larger  $C_{OUT}$  is required (22- $\mu$ F tantalum or 150- $\mu$ F aluminum electrolytic).

$$X_{CADJ} = \frac{1}{2\pi f_{ripple} C_{ADJ}}$$
 is < R1 to

- C. CIN is recommended if TLV1117 is not located near the power-supply filter.
- D. An external diode is recommended to protect the regulator if the input instantaneously is shorted to GND.

Figure 13. Basic Adjustable Regulator



## **MECHANICAL DATA**

MPDS094A - APRIL 2001 - REVISED JUNE 2002



- B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion.
  - D. Falls within JEDEC TO-261 Variation AA.



MPFM001E - OCTOBER 1994 - REVISED JANUARY 2001

#### PowerFLEX<sup>™</sup> PLASTIC FLANGE-MOUNT



- NOTES: A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. The center lead is in electrical contact with the thermal tab.
  - D. Dimensions do not include mold protrusions, not to exceed 0.006 (0,15).
  - E. Falls within JEDEC MO-169

**KTE (R-PSFM-G3)** 

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## **MECHANICAL DATA**

MPSF001F - JANUARY 1996 - REVISED JANUARY 2002

#### KTP (R-PSFM-G2)

### PowerFLEX<sup>™</sup> PLASTIC FLANGE-MOUNT PACKAGE



- NOTES: A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. The center lead is in electrical contact with the thermal tab.
  - D. Dimensions do not include mold protrusions, not to exceed 0.006 (0,15).
  - E. Falls within JEDEC TO-252 variation AC.

PowerFLEX is a trademark of Texas Instruments.

KCS (R-PSFM-T3)

PLASTIC FLANGE-MOUNT PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.  $\triangle$
- Lead dimensions are not controlled within this area.
- D. All lead dimensions apply before solder dip.
- E. The center lead is in electrical contact with the mounting tab.  $\hfill \wedge$
- $\stackrel{\frown}{\not E}$  The chamfer is optional.
- A Thermal pad contour optional within these dimensions.
- $m \AA$  Falls within JEDEC TO-220 variation AB, except minimum lead thickness and minimum exposed pad length.



KC (R-PSFM-T3)

PLASTIC FLANGE-MOUNT PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Lead dimensions are not controlled within this area.

D. All lead dimensions apply before solder dip.

- E. The center lead is in electrical contact with the mounting tab.
- $\frown$  The chamfer is optional.
- A Thermal pad contour optional within these dimensions.
- 🖄 Falls within JEDEC TO-220 variation AB, except minimum lead thickness.



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